

NO. PINS

PER ROW

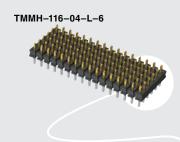
OPTION

-ES

-EC

-EP & -EPC

-EL & -EBC



(2.00 mm) .0787"

BLE THROUGH-HOLE HEADER

SPECIFICATIONS

For complete specifications see www.samtec.com?TMMH

Insulator Material: Black Liquid Crystal Polymer
Terminal Material:

Phosphor Bronze
Plating:
Sn or Au over
50 µ" (1.27 µm) Ni
Current Rating (TMMH/ESQT): 4.5 A per pin (1 pin powered per row)

Current Rating (TMMH/SQT):

5.1 A per pin

5.1 A per pin
(1 pin powered per row)
Operating Temp Range:
-55 °C to +105 °C with Tin;
-55 °C to +125 °C with Gold
Voltage Rating:
281 VAC mated with SQW;
250 VAC mated with SQT

RoHS Compliant:

Lead-Free Solderable: Yes

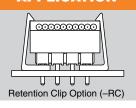
Board Mates:

CLT, SQT, SQW, ESQT, TLE, SMM, MMS

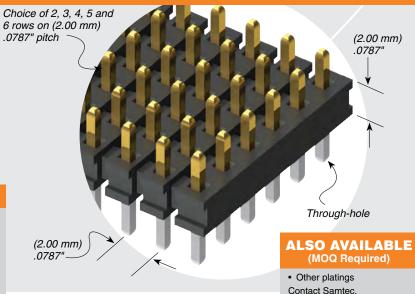
Cable Mates:



APPLICATION



тммн



RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Note:

Some lengths, styles and options are non-standard, non-returnable.

Other Solutions







Surface Mount

See previous page.



Low Profile



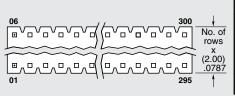
Right-angle **Four Row** See TMM Series.



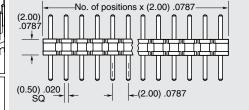
See TMMS Series.

Paste In Hole (PIH) processing. Contact Samtec ASP Group for part customization.

03 thru 50



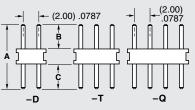
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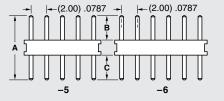


LEAD STYLE

Specify LEAD STYLE from chart

Z	LEAD STYLE	Α	В	C
(2.92)	-01	(7.67) .302	(3.20) .126	(2.46) .097
(4.70) .185	-04	(6.45) .254	(1.91) .075	(2.57) .101
(6.10) .240	-05	(5.94) .234	(1.65) .065	(2.29) .090
(4.45)	-06	(8.74)	(3.20)	(3.53)





PLATING OPTION

= Gold flash on post, Matte Tin on tail

= 10 µ" (0.25 µm) Gold on post, Matte Tin on tail

-Т = Matte Tin



